

In The United States Patent and Trademark Office

Application Number: 10/627,201

Examiner: Wright, Ingrid D

Applicant(s): Shi-Feng Shao

Group Art Unit: 2835

Filing Date: 07/23/2003

Title: Heat Dissipating Arrangement for Portable Computer

Date: 10/20/2006



DECLARATION UNDER RULE 132

Honorable Commissioner for Patents,
P.O. Box 1450,
Alexandria, VA 22313-1450

Sir:

I, Shi-Feng SHAO, hereby attest as follows:

I am the inventor of the above-identified U.S. Patent Application Serial No. 10/627,201, entitled "Heat Dissipating Arrangement for Portable Computer" (the '201 application).

Commercial Success

My company currently makes and sells a heat dissipating arrangement embodying the subject of the '201 application. This heat dissipating arrangement is sold under the company, Kunshan Anli Precise Metal CO., LTD in China, and was introduced commercially throughout the United States and China. Over 417,403 pieces and over total amount of USD 100017.36 of the heat dissipating arrangement containing the structure of the instant invention have been sold in stores and the recently sale records are as follows:

(1) Over 20000 pieces and the amount of USD 10,000.00 of the instant invention were sold at September 25, 2006.

(2) Over 360067 pieces and the amount of USD 71,906.25 the instant invention were sold at September 26, 2006.

(3) Over 32000 pieces and the amount of USD 16,746.40 of the instant invention were sold at October 6, 2006.

(4) Over 5336 pieces and the amount of USD 1364.71 of the instant invention were sold at October 13, 2006.

In my opinion, an important reason for the commercial success of the heat dissipating arrangement is the structural configuration which has been expressed in the '201 application. Therefore, the subject matter of the heat dissipating arrangement exhibits relative to others available in the market is an important reason for the commercial success of the heat dissipating arrangement.

All statements made of my own knowledge are true and all statements made on information and belief to be true. I acknowledge that willful false statements and the like are punishable by fine, imprisonment, or both under 18 U.S.C. 1001 and may jeopardize the validity of the application or any patent issuing thereon.

By: 

Shi-Feng Shao

Date: 2006. 10. 20